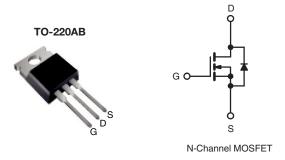
Vishay Siliconix

HALOGEN FREE

D Series Power MOSFET

| PRODUCT SUMMARY | | | | | |
|--|------------------------------|--|--|--|--|
| V _{DS} (V) at T _J max. | 650 | | | | |
| R _{DS(on)} max. at 25 °C (Ω) | V _{GS} = 10 V 0.340 | | | | |
| Q _g (Max.) (nC) | 90 | | | | |
| Q _{gs} (nC) | 14 | | | | |
| Q _{gd} (nC) | 22 | | | | |
| Configuration | Single | | | | |



FEATURES

- Optimal Design
 - Low Area Specific On-Resistance
 - Low Input Capacitance (Ciss)
 - Reduced Capacitive Switching Losses
 - High Body Diode Ruggedness
 - Avalanche Energy Rated (UIS)
- Optimal Efficiency and Operation
 - Low Cost
 - Simple Gate Drive Circuitry
 - Low Figure-of-Merit (FOM): Ron x Qa
 - Fast Switching
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Consumer Electronics
 - Displays (LCD or Plasma TV)
- Lighting
- Industrial
 - Welding
 - Induction Heating
 - Motor Drives
 - Battery Chargers
- SMPS

| ORDERING INFORMATION | | | | |
|---------------------------------|----------------|--|--|--|
| Package | TO-220AB | | | |
| Lead (Pb)-free | SiHP17N60D-E3 | | | |
| Lead (Pb)-free and Halogen-free | SiHP17N60D-GE3 | | | |

| ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted) | | | | | | |
|--|-------------------------|-------------------------|-----------------------------------|---------------|------|--|
| PARAMETER | | | SYMBOL | LIMIT | UNIT | |
| Drain-Source Voltage | | | V_{DS} | 600 | V | |
| Gate-Source Voltage | | | V_{GS} | ± 30 | V | |
| Continuous Proin Current /T = 150 °C) | V _{GS} at 10 V | T _C = 25 °C | - I _D | 17 | | |
| Continuous Drain Current (T _J = 150 °C) | | T _C = 100 °C | | 10.7 | Α | |
| Pulsed Drain Current ^a | | | I _{DM} | 48 | | |
| Linear Derating Factor | | | | 2.22 | W/°C | |
| Single Pulse Avalanche Energy ^b | | | E _{AS} | 165.6 | mJ | |
| Maximum Power Dissipation | | | P_{D} | 277.8 | W | |
| Operating Junction and Storage Temperature Range | | | T _J , T _{stg} | - 55 to + 150 | °C | |
| Drain-Source Voltage Slope T _J = 125 °C | | dV/dt | 24 | 1// | | |
| Reverse Diode dV/dt ^d | | | 0.2 | - V/ns | | |
| Soldering Recommendations (Peak Temperature) ^c for 10 s | | | | 300 | °C | |

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. $V_{DD} = 50 \text{ V}$, starting $T_J = 25 \,^{\circ}\text{C}$, $L = 2.3 \,^{\circ}\text{mH}$, $R_q = 25 \,^{\circ}\Omega$, $I_{AS} = 12 \,^{\circ}\text{A}$.
- c. 1.6 mm from case.
- d. $I_{SD} \le I_D$, starting $T_J = 25$ °C.



Vishay Siliconix

| THERMAL RESISTANCE RATINGS | | | | | |
|----------------------------------|------------|------|------|------|--|
| PARAMETER | SYMBOL | TYP. | MAX. | UNIT | |
| Maximum Junction-to-Ambient | R_{thJA} | - | 62 | °C/W | |
| Maximum Junction-to-Case (Drain) | R_{thJC} | - | 0.45 | 5/44 | |

| PARAMETER | SYMBOL | TEST CONDITIONS | | MIN. | TYP. | MAX. | UNIT |
|---|-----------------------|--|--|------|-------|-------|------|
| Static | | | | | | L | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | | 600 | - | - | V |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | Referenc | e to 25 °C, I _D = 1 mA | - | 0.7 | - | V/°C |
| Gate-Source Threshold Voltage (N) | V _{GS(th)} | V _{DS} : | $V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$ | | - | 5 | V |
| Gate-Source Leakage | I _{GSS} | | V _{GS} = ± 30 V | - | - | ± 100 | nA |
| Zero Gate Voltage Drain Current | I _{DSS} | | = 600 V, V _{GS} = 0 V /, V _{GS} = 0 V, T _J = 125 °C | - | - | 1 | μA |
| Drain-Source On-State Resistance | R _{DS(on)} | $V_{GS} = 480 \text{ V}$ | I _D = 8 A | _ | 0.275 | 0.340 | Ω |
| Forward Transconductance ^a | 9fs | | $S = 50 \text{ V}, I_D = 8 \text{ A}$ | - | 6.2 | - | S |
| Dynamic | 0.0 | | , , , , | | | L | |
| Input Capacitance | C _{iss} | | V _{GS} = 0 V, | - | 1780 | | pF |
| Output Capacitance | C _{oss} | | $V_{DS} = 100 \text{ V},$ | - | 140 | - | |
| Reverse Transfer Capacitance | C _{rss} | f = 1 MHz | | - | 15 | - | |
| Total Gate Charge | Qq | | | - | 45 | 90 | |
| Gate-Source Charge | Q _{gs} | V _{GS} = 10 V | $I_D = 8 A, V_{DS} = 480 V$ | - | 14 | - | nC |
| Gate-Drain Charge | Q _{gd} | | 1 - 1 | | 22 | - | 1 |
| Turn-On Delay Time | t _{d(on)} | | | - | 22 | 45 | - ns |
| Rise Time | t _r | V_{DD} | $V_{DD} = 300 \text{ V}, I_D = 8 \text{ A}$ $R_g = 9.1 \Omega, V_{GS} = 10 \text{ V}$ | | 56 | 85 | |
| Turn-Off Delay Time | t _{d(off)} | $R_g = 1$ | | | 37 | 75 | |
| Fall Time | t _f | | | - | 30 | 60 | |
| Internal Gate Resistance | R_g | f = 1 MHz, open drain | | - | 1.6 | - | Ω |
| Drain-Source Body Diode Characteristic | s | | | | | | |
| Continuous Source-Drain Diode Current | I _S | MOSFET symbol showing the integral reverse p - n junction diode | | - | _ | 17 | Α |
| Pulsed Diode Forward Current | I _{SM} | | | - | - | 48 | |
| Body Diode Voltage | V _{SD} | T _J = 25 °C, I _S = 8 A, V _{GS} = 0 V | | - | - | 1.5 | V |
| Body Diode Reverse Recovery Time | t _{rr} | T _J = 25 °C, $I_F = I_S$, $dI/dt = 100 \text{ A/}\mu\text{s}, V_R = 20 \text{ V}$ | | - | 633 | 950 | ns |
| Body Diode Reverse Recovery Charge | Q _{rr} | | | - | 7 | 15 | μC |
| Reverse Recovery Current | I _{RRM} | | | - | 21 | 42 | Α |

Note

a. Repetitive rating; pulse width limited by maximum junction temperature.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

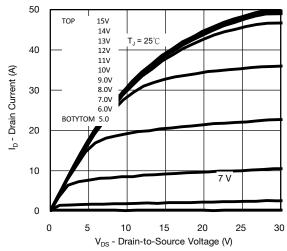


Fig. 1 - Typical Output Characteristics, T_C = 150 °C

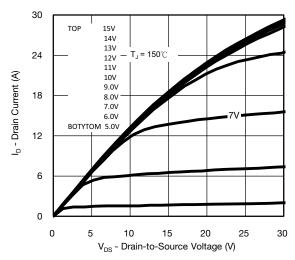


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

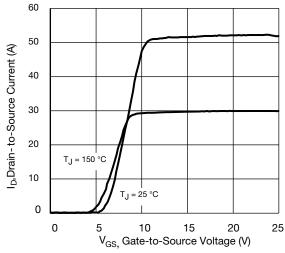


Fig. 3 - Typical Transfer Characteristics

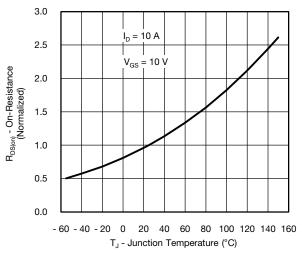


Fig. 4 - Normalized On-Resistance vs. Temperature

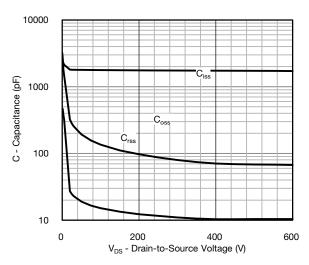


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

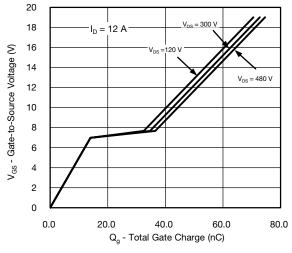


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



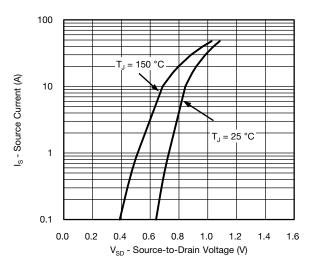


Fig. 7 - Typical Source-Drain Diode Forward Voltage

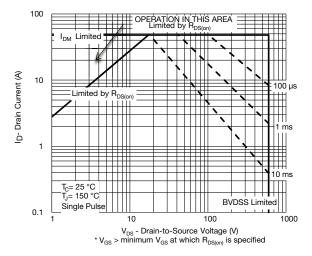


Fig. 8 - Maximum Safe Operating Area

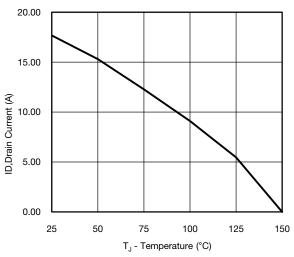


Fig. 9 - Maximum Drain Current vs. Case Temperature

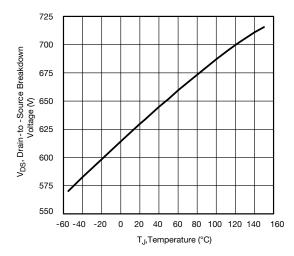


Fig. 10 - Typical Drain-to-Source Voltage vs. Temperature

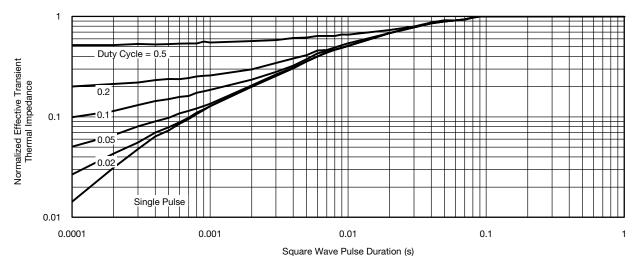


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case



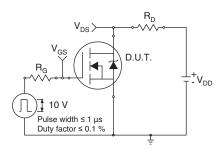


Fig. 12 - Switching Time Test Circuit

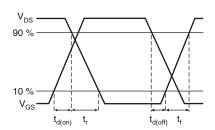


Fig. 13 - Switching Time Waveforms

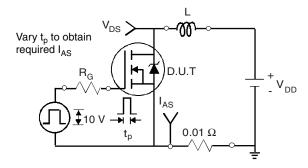


Fig. 14 - Unclamped Inductive Test Circuit

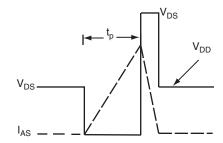


Fig. 15 - Unclamped Inductive Waveforms

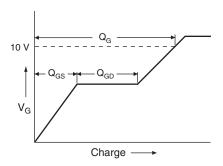


Fig. 16 - Basic Gate Charge Waveform

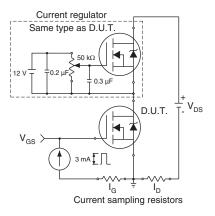
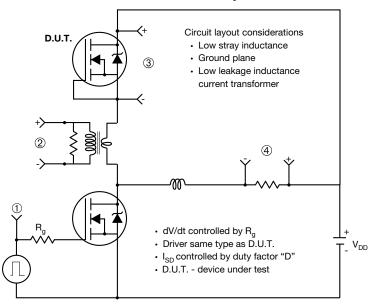


Fig. 17 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



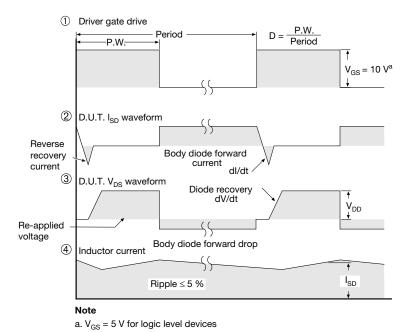


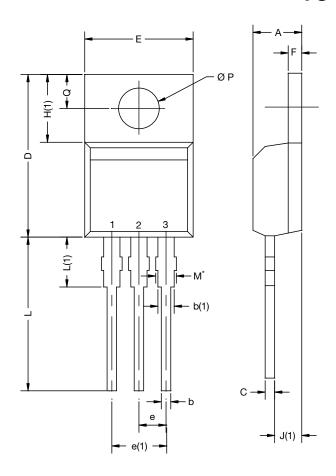
Fig. 18 - For N-Channel

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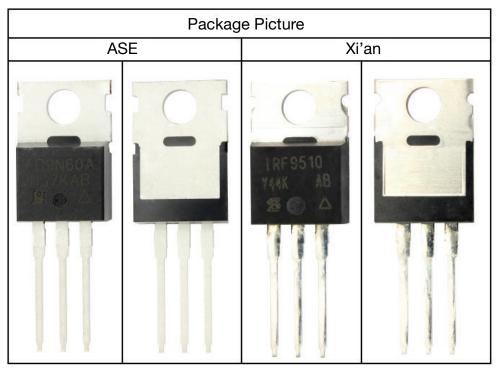
TO-220-1



| DIM | MILLIN | IETERS | INCHES | | |
|--|--------|--------|--------|-------|--|
| DIM. | MIN. | MAX. | MIN. | MAX. | |
| Α | 4.24 | 4.65 | 0.167 | 0.183 | |
| b | 0.69 | 1.02 | 0.027 | 0.040 | |
| b(1) | 1.14 | 1.78 | 0.045 | 0.070 | |
| С | 0.36 | 0.61 | 0.014 | 0.024 | |
| D | 14.33 | 15.85 | 0.564 | 0.624 | |
| E | 9.96 | 10.52 | 0.392 | 0.414 | |
| е | 2.41 | 2.67 | 0.095 | 0.105 | |
| e(1) | 4.88 | 5.28 | 0.192 | 0.208 | |
| F | 1.14 | 1.40 | 0.045 | 0.055 | |
| H(1) | 6.10 | 6.71 | 0.240 | 0.264 | |
| J(1) | 2.41 | 2.92 | 0.095 | 0.115 | |
| L | 13.36 | 14.40 | 0.526 | 0.567 | |
| L(1) | 3.33 | 4.04 | 0.131 | 0.159 | |
| ØР | 3.53 | 3.94 | 0.139 | 0.155 | |
| Q | 2.54 | 3.00 | 0.100 | 0.118 | |
| ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031 | | | | | |

Note

 \bullet $M^{\star}=0.052$ inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



Revison: 14-Dec-15 1 Document Number: 66542



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Vishay

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